

FORM PTO-1595 (Rev. 10/02)			U.S. DE	U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office		
Docket No.: 62807-244	1029508	33.		ratent and i	rademark Office	
To the Honorable Commissioner for Patents and Trademarks: Please record the attached original documents or copy thereto:						
1. Name of Conveying Party(ies):			2. Name and address of receiving party(ies):			
Tadashi FUJIEDA, Kishio HIDAKA and Mitsuo HAYASHIBARA		Name:	me: Hitachi High-Technologies Corporation			
		Address:	24-14, Nishi Shinbashi	1-chome,	0	
Additional name(s) of conveying party(ies) attached?   Yes   No			Minato-ku, Tokyo, JAP	AN	T -	
3. Nature of Conveyance:					57.5	
☐ Assignment ☐ Merg	ger				)55 170	
☐ Security Agreement ☐ Chan	ge of Name				326 1/( 02	
☐ Other						
Execution Date: December 27; December 28; as	nd December 27,					
2004 (respectively)						
		Additional	name(s) & address(es) at	ttached?	Yes 🛛 No	
4. Application number(s) or patent number(s):						
If the document is being filed together with a new application, the execution date of the application is:  December 27; December 28; and December 27,						
				2004 (res		
A. Patent Application No(s).		B. Patent	No(s).			
Additional numbers attached?  Yes No						
5. Name and address of party to whom correspond	dence	6. Total no	umber of applications and	d patents inv	olved: 1	
concerning document should be mailed:						
Name: MCDERMOTT WILL & EMERY LI	LP	7. Total fe	ee (37 CFR 3.41)		\$40.00	
Internal Address:		Enc	closed			
		🛛 Au	thorized to be charged to	deposit acco	ount	
Street Address: 600 13th Street, N.W.		8. Deposit account number:				
		500417	7			
City: Washington State: D. C.	Zip: 20005-3096					
DO NOT USE THIS SPACE						
9. Statement and signature.						
To the best of my knowledge and belief, t	he foregoing informa	tion is true	and correct and any attac	ched copy is	a true copy	
of the original document.						
	L.	y/ <				
Keith E. George, Registration No. 34,111		2.5	eseg.	February	17, 2005	
Name and Registration No. of Person Signing		Signature			ate	
	To	tal number	of pages including cover	sheet:	2	
OMB No. 0651-0027 (exp. 6/30/2005)	,	· _ ·				
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**PATENT** 

**REEL: 016305 FRAME: 0076** 

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishi Shinbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

FIELD EMISSION GUN AND ELECTRON BEAM INSTRUMENTS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

**RECORDED: 02/17/2005** 

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Jadashi Jujieda  Tadashi FUJIEDA	12/27/2004
2)	Tichio Hidaka	12/28/2004
3)	Jadashi Jupeda  Tadashi FUJIEDA  Jihi Thidaha  Kishio HIDAKA  Mitsuo Hayashilan  Mitsuo HAYASHIBARA	12/28/2004 12/28/2004
4)		
5)		
6)		
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10)		

PATENT REEL: 016305 FRAME: 0077